

Electronic Acknowledgement Receipt

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Application Number:	10821432
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Title of Invention:	HIGH VOLTAGE SEMICONDUCTOR DEVICE UTILIZING A DEEP TRENCH STRUCTURE
First Named Inventor:	Chen-Bau Wu
Customer Number:	42717
Filer:	David M. Odell/Denise Wilson
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Issue Fee Payment Recorded	issuefee.pdf	90851	no	1

Warnings:					
Information:					
2	Fee Worksheet (PTO-875)	fee-info.pdf	8322	no	2
Warnings:					
Information:					
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<p>This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.</p> <p><u>New Applications Under 35 U.S.C. 111</u> If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.</p> <p><u>National Stage of an International Application under 35 U.S.C. 371</u> If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p>					